



IC DRIVABLE PC BOARD **RELAY FOR FIELD LOAD SWITCHING**

RU (1) (\$) ST RELAYS



FEATURES

- · Sealed to meet the combination process of automatic wave soldering and cleaning needs
- Latching types available
- · High switching capacity and high sensitivity in subminiature size 150 mW pick-up, 8 A inrush capacity: 51 A for 1a1b, 35 A for 2a
- High shock and vibration resistance Shock: 20 G, Vibration: 10 to 55 Hz at double amplitude of 2 mm

About Cd-free contacts

We have introduced Cadmium free type products to reduce Environmental Hazardous Substances.

(The suffix "F" should be added to the part number)

Please replace parts containing Cadmium with Cadmium-free products and evaluate them with your actual application before use because the life of a relay depends on the contact material and load

RoHS Directive compatibility information http://www.nais-e.com/

SPECIFICATIONS

Contacts

Arrangemen	t	1 Form A 1 Form B	2 Form A	
Contact mate	erial	Au-flashed AgSnO ₂ type		
Initial contac	t resistance	30 m Ω		
	Max. switching power		2,000 VA, 150 W	
Rating	Max. switching voltage		380 V AC, 250 V DC	
(resistive)	Max. switching current		8 A	
	Min. switch	ning capacity#1	100 mA, 5 V DC	
HP rating		1/4 HP 125, 250 V AC		
Inrush current capability			51 A (TV-3 equivalence) for 1a1b 35 A (TV-1 equivalence) for 2a	
Expected life (min. operations)	Mechanical (at 180 cpm)		107	
	Electrical	8 A 250 V AC (resistive)	(ON : OFF)5 = 1 s : 5 s)

Coil (polarized) (at 25°C 77°F)

Single side stable	Nominal operating power	Approx. 240 mW
Latching	Nominal set and reset power	Approx. 240 mW

^{#1} This value can change due to the switching frequency, environmental conditions, and desired reliability level, therefore it is recommended to check this with the actual load.

Remarks

- Specifications will vary with foreign standards certification ratings.
- Measurement at same location as "Initial breakdown voltage" section
- *2 Detection current: 10 mA
- \star_3 Wave is standard shock voltage of $\pm 1.2 \times 50 \mu s$ according to JEC-212-1981 *4 Excluding contact bounce time
- *5 Half-wave pulse of sine wave: 11ms; detection time: 10μs
- *6 Half-wave pulse of sine wave: 6ms
- *7 Detection time: 10μs
- *8 Refer to 6. Conditions for operation, transport and storage mentioned in AMBIENT ENVIRONMENT

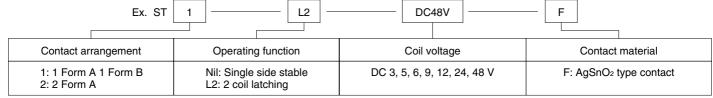
Characteristics (at 25°C 77°F 50% Relative humidity)

Max. operating speed			20 cpm (at rated load)		
Initial insulation resistance*1			1,000 MΩ (at 500 V DC)		
Initial	Between contact sets		2,000 Vrms		
breakdown	Between open contacts		1,200 Vrms		
voltage*2	Between contacts and coil		3,750 Vrms		
Surge voltage between coil and contact*3			Min. 6,000 V		
Operate time*4 (at nominal voltage)			Max. 15 ms (Approx. 10 ms)		
Release time (without diode)*4 (at nominal voltage)			Max. 10 ms (Approx. 8 ms)		
Set time*4 (latching) (at nominal voltage)			Max. 10 ms (Approx. 8 ms)		
Reset time*4 (latching) (at nominal voltage)			Max. 10 ms (Approx. 8 ms)		
Temperature rise (at 60°C)			Max. 55°C with nominal coil voltage and at 8 A switching current		
Shock resistance		Functional*5	Min. 196 m/s ² {20 G}		
		Destructive*6	Min. 980 m/s ² {100 G}		
Vibration		Functional*7	117.6 m/s ² {12 G}, 10 to 55 Hz at double amplitude of 2 mm		
resistance		Destructive	176.4 m/s² {18 G}, 10 to 55 Hz at double amplitude of 3 mm		
Conditions for		Ambient	–40°C to +60°C		
transport and	g and at low	temp.	-40°Fto +140°F		
(Not freezing condensing temperature		Humidity	5 to 85% R.H.		
Unit weight			Approx. 10g .353 oz		

TYPICAL APPLICATIONS

Sequence controllers, facsimiles, telephone controls, remote control security devices and security equipment.

ORDERING INFORMATION



(Notes) 1. Standard packing: Carton; 50 pcs., Case; 500 pcs.

TYPES AND COIL DATA (at 20°C 68°F)

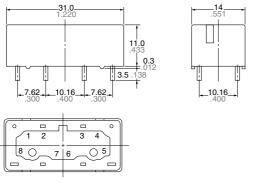
Single side stable

Part No.		Nominal	Diek un veltege	Drop-out	Maximum	Coil resistance,	Nominal
1 Form A 1 Form B	2 Form A	voltage, V DC	Pick-up voltage, V DC (max.)	voltage, V DC (min.)	allowable voltage, V DC (60°C 140°F)	Ω (±10%)	operating current, mA
ST1-DC3V-F	ST2-DC3V-F	3	2.4	0.3	4.5	38	78.9
ST1-DC5V-F	ST2-DC5V-F	5	4.0	0.5	7.5	105	47.6
ST1-DC6V-F	ST2-DC6V-F	6	4.8	0.6	9.0	150	40
ST1-DC9V-F	ST2-DC9V-F	9	7.2	0.9	13.5	360	25
ST1-DC12V-F	ST2-DC12V-F	12	9.6	1.2	18.0	600	20
ST1-DC24V-F	ST2-DC24V-F	24	19.2	2.4	36.0	2,400	10
ST1-DC48V-F	ST2-DC48V-F	48	38.4	4.8	72.0	9,000	5.3

2 coil latching

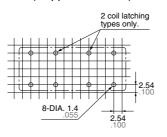
Part No.		Nominal	Set and reset	Maximum allowable voltage,	Coil resistance,	Nominal
1 Form A 1 Form B	2 Form A	voltage, V DC	voltage, V DC (max.)	V DC (60°C 140°F)	Ω (±10%)	operating current, mA
ST1-L2-DC3V-F	ST2-L2-DC3V-F	3	2.4	4.5	40	75
ST1-L2-DC5V-F	ST2-L2-DC5V-F	5	4.0	7.5	110	45.5
ST1-L2-DC6V-F	ST2-L2-DC6V-F	6	4.8	9.0	155	38.7
ST1-L2-DC9V-F	ST2-L2-DC9V-F	9	7.2	13.5	360	25
ST1-L2-DC12V-F	ST2-L2-DC12V-F	12	9.6	18.0	640	18.8
ST1-L2-DC24V-F	ST2-L2-DC24V-F	24	19.2	36.0	2,400	10
ST1-L2-DC48V-F	ST2-L2-DC48V-F	48	38.4	72.0	10,200	4.7

DIMENSIONS



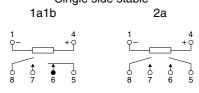
General tolerance: ±0.2 ±.008

PC board pattern (Copper-side view)

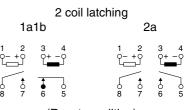


Tolerance: ±0.1 ±.004

Schematic (Bottom view) Single side stable



(Deenergized condition)



(Reset condition)

Diagram shows the "reset" position when terminals 3 and 4 are energized. Energize terminals 1 and 2 to transfer contacts.

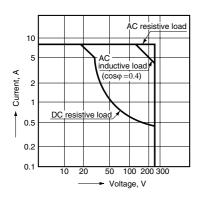
Diagram shows the "reset" position when terminals 3 and 4 are energized. Energize terminals 1 and 2 to transfer contacts.

mm inch

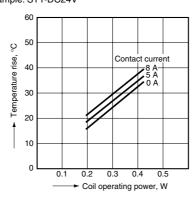
^{2. 1} coil latching type available.

REFERENCE DATA

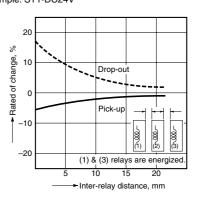
1. Max. switching power



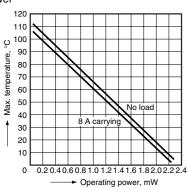
2. Coil temperature rise Sample: ST1-DC24V



3. Influence of adjacent mounting Sample: ST1-DC24V



4. Max. ambient temperature by operating power



ST relay socket



Solder terminal socket

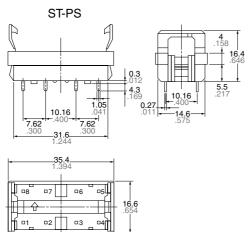


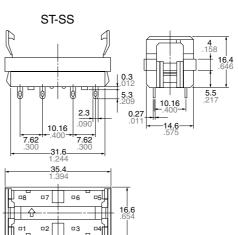
PC board terminal socket

Specifications

4,000 Vrms Coil/Contacts 2,000 Vrms Contacts/Contacts
More than 1,000 $M\Omega$ between terminals
150°C (302°F) for 1 hr
10 A
15 times

DIMENSIONS mm inch

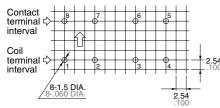




Precautions for use (socket)

1. PC board mounting method

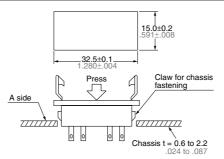
PC board pattern



The terminal configuration is symmetrical on the left and right, so an arrow mark ☆ is stamped on the socket to prevent misinsertion. We recommend printing the same arrow mark ☆ on the component mounting side (side opposite from pattern) of the PC board. In this case, the terminal configuration becomes the terminal nos. noted near the drilling holes.

2. Chassis cutout

Chassis cutting dimensions



If the chassis hole is punched with a press, set so the release R on the front side (A side).

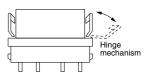
The range for chassis thickness is 0.6 to 2.2 mm .024 to .087 inch.

3. Relay mounting and removal

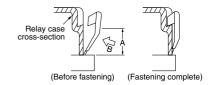
(1) Align the directions of the relay and socket.



(2) Insert the relay all the way in, so it is securely in place.



(3) Press the part indicated by A in the B direction, and fasten by placing the hook on the relay.



(4). When removing the relay, completely release the hooks on both sides and pull the relay out.

For Cautions for Use, see Relay Technical Information